Listing of Claims

This listing of claims replaces all prior claims of the captioned patent application.

Claim 1. (original) A platen for use in a chemical mechanical planarization (CMP) system, comprising:

a structure configured with at least one aperture for defining at least one localized fluid pressure platen zone; and

at least one membrane covering the at least one aperture to prevent fluid of the at least one localized fluid pressure platen zone from exiting the structure.

Claim 2. (original) A platen as recited in claim 1, wherein:

the at least one membrane is configured with at least one first section secured to the structure around the at least one aperture.

Claim 3. (currently amended) A platen as recited in claim 2, wherein:

the <u>at least one</u> membrane is configured with a second section surrounded by the at least one first section, and

the second section is flexible for movement relative to the at least one aperture in response to the fluid of the at least one localized fluid pressure platen zone.

Claim 4. (original) A platen as recited in claim 3, wherein:

the movement of the second section relative to the at least one aperture is movement away from the at least one aperture in response to the fluid of the at least one localized fluid pressure platen zone.

Claim 5. (original) A platen as recited in claim 3, wherein:

the movement of the second section relative to the at least one aperture is movement toward the at least one aperture in response to the fluid of the at least one localized fluid pressure platen zone.

Claim 6. (original) A platen as recited in claim 1, wherein:

the at least one localized fluid pressure platen zone is defined by a plurality of the apertures; and

the at least one membrane covers all of the plurality of the apertures.

Claim 7. (currently amended)) A platen as recited in claim 1, wherein:

he at least one localized fluid pressure platen zone is defined by a plurality of the <u>at least one aperture</u> apertures, the apertures being organized in separate groups; and

the at least one membrane comprises a separate membrane covering <u>each</u> separate <u>group</u> groups of the plurality of the apertures, each separate membrane is configured so that the separate membranes may collectively apply differential polishing pressures to the wafer.

Claim 8. (currently amended) A platen for use in a chemical mechanical planarization

(CMP) system, comprising:

at least one fluid-bearing platen zone having a plurality of fluid-bearing outlets

for supplying fluid-bearing fluid, the at least one fluid-bearing platen zone being

disposed below and being capable of providing fluid-bearing pressure on a polishing

pad; and

at least one fluid-pressure platen zone comprising at least one fluid pressure

port for transferring fluid-pressure fluid relative to the at least one fluid-bearing platen

zone and the polishing pad, the at least one fluid pressure platen zone being disposed

below the polishing pad, the at least one fluid pressure platen zone further comprising

at least one a member configured to define at least one a flexible pocket covering the

at least one fluid pressure port to prevent the fluid-pressure fluid from freely-flowing

relative to the at least one fluid-bearing zone.

Claim 9. (currently amended) A platen as recited in claim 8, wherein the fluid-

pressure fluid transferred by the at least one fluid pressure port flexes the at least one

flexible pocket to configure the at least one flexible member so that the polishing pad

achieves a particular polishing profile during a CMP operation.

Claim 10. (original) A platen as recited in claim 9, wherein a value of fluid pressure

of the fluid-pressure fluid transferred by the at least one fluid pressure port is a static

pressure value that is controlled relative to a value of a pressure of the fluid-bearing

fluid.

Claim 11. (original) A platen as recited in claim 9, wherein a value of fluid pressure

of the fluid-pressure fluid in the flexible pocket is a static pressure having a value in a

range of pressure from about 1 to 2 psi greater than a value of a pressure of the fluid-

bearing fluid.

Claim 12. (currently amended) A platen as recited in claim 9, wherein:

the fluid-bearing fluid has a tendency to freely-flow from the at least one

fluid-bearing zone and out of the platen; and

the flexure of the at least one flexible pocket in response to the fluid-pressure

fluid transferred by the at least one fluid pressure port configures the at least one

flexible pocket so that the at least one flexible pocket restricts the tendency of the

fluid-bearing fluid to freely-flow.

Claim 13. (currently amended) A platen as recited in claim 8, wherein:

the fluid-bearing outlets of the at least one fluid-bearing zone are located at a

position corresponding to a central area of a wafer to be polished so that the fluid-

bearing fluid tends to freely-flow in a fluid-bearing gap away from the position to

provide the fluid-bearing pressure to the polishing pad; and

the fluid-pressure fluid transferred relative to the at least one fluid pressure

port of the at least one fluid pressure zone deforms the at least one flexible member

into the fluid-bearing gap to restrict the tendency of the fluid-bearing fluid to freely-

flow in the fluid-bearing gap away from the position while the fluid-bearing fluid still

provides the fluid-bearing pressure to the polishing pad.

Claim 14. (original) A platen for use in a chemical mechanical planarization (CMP)

system in which a polishing pad is configurable to apply selected polishing pressures

to different areas of a wafer to be planarized, the platen comprising:

a fluid-bearing structure configured with a first plurality of apertures for

transferring polishing pressure control fluid, the apertures being configured to define a

plurality of localized fluid pressure platen zones for applying selectable polishing

pressure control pressures to the polishing pad; and

a membrane corresponding to each localized fluid pressure platen zone, each

membrane covering respective ones of the apertures corresponding to a respective one

of the localized fluid pressure platen zones, each membrane being sealed to the fluid-

bearing structure to separate the polishing pressure control fluid of the respective

localized fluid pressure zone from the fluid-bearing structure, the sealing of each

membrane enabling different selectable localized fluid pressures to be applied to each

localized fluid pressure platen zone to provide differential polishing pressure control

pressures to the polishing pad.

Claim 15. (original) A platen as recited in claim 14, wherein:

the fluid-bearing structure is further configured with a second plurality of

apertures for supplying fluid-bearing fluid, the second plurality of apertures being

configured to define a second plurality of localized fluid-bearing zones for supporting

the polishing pad, the fluid-bearing structure being further configured with a gap that

is normally open to permit relatively free-flow of the fluid-bearing fluid to exit the

fluid-bearing structure; and

each of the membranes is sealed to the fluid-bearing structure along the gap

and responds to the polishing pressure control fluid from one or more of the apertures

of the respective first plurality of apertures to restrict the gap and limit the flow of the fluid-bearing fluid from the fluid-bearing structure.

Claim 16. (original) A platen as recited in claim 15, wherein:

each sealed membrane responds to the polishing pressure control fluid by becoming inflated to define a pocket that extends at least partially across the gap to limit the flow of the fluid-bearing fluid from the fluid-bearing structure.

Claim 17. (original) A platen as recited in claim 14, wherein:

the polishing pad is configured as an endless belt;

the fluid-bearing structure provides a gap filled with fluid-bearing fluid for supporting the endless belt spaced from the platen; and

each membrane is reconfigured by the polishing pressure control fluid received from the respective first plurality of apertures of the plurality of the respective localized fluid pressure zone so that the reconfigured membrane enters the gap and restricts the flow of the fluid-bearing fluid through the gap.

Claim 18. (currently amended) A method of limiting consumption of fluid in a platen of a chemical mechanical planarization system, comprising the operations of:

providing the platen with at least one aperture for defining at least one localized fluid pressure platen zone; and

sealing the at least one aperture with at least one a flexible membrane secured around the at least one aperture to prevent fluid of the at least one localized fluid pressure platen zone from exiting the platen.

Claim 19. (currently amended) A method as recited in claim 18, wherein the platen

defines a gap between a polishing pad and the platen, the method further comprising

the operations of:

transferring the fluid of the at least one localized fluid pressure platen zone

relative to the at least one aperture to cause the at least one membrane to flex; and

controlling the transferring operation to control a localized planarization

pressure applied via the polishing pad to a workpiece.

Claim 20. (currently amended) A method as recited in claim 18, wherein the platen is

a fluid-bearing platen and defines a fluid-bearing gap between a polishing pad and the

fluid-bearing platen, the fluid-bearing gap extending outwardly from a central platen

zone to the at least one localized fluid pressure zone, the method further comprising

the operations of:

configuring the fluid-bearing platen with a plurality of apertures of the at least

one aperture for defining the at least one localized fluid pressure zone outwardly of

the central platen zone;

transferring the fluid of the at least one localized fluid pressure zone relative to

each of the plurality of apertures to cause the respective at least one membrane sealing

the respective aperture to flex; and

controlling the transferring operation to cause the respective flexed at least one

membrane membranes to control a localized fluid pressure applied to the polishing

pad and a resulting localized planarization pressure applied via the polishing pad to a

workpiece;

App. No. 10/607,613 Amend. Dated 10/4/04 Response To Action dated 8/3/04

wherein the flexed <u>at least one</u> membrane enters the gap to restrict fluid-bearing fluid of the fluid-bearing platen from exiting the fluid-bearing platen through the fluid-bearing gap.

Summary: This Amendment and Response makes the required election of

species, identifies the claims that define the elected species, summarizes the telephone

interview with the Examiner held on September 29, 2004, and amends the claims to

make claims 8, 9, 13, and 18-20 be generic, and to have claims 3, 7, 12, and 13 refer

properly to antecedents.

Election and Claim Identification In Re Species 2: In response to the Election

Requirement dated August 3, 2004, Applicants hereby elect species 2 to prosecute in

the above-identified patent application if no generic claim is finally held to be

allowable. The claims that correspond to species 2 are: amended claim 7, and claims

14-17. Claims 1-6, 8-13, and 18-20 are believed to be generic and thus also cover

species 2.

<u>Telephone Interview</u>: Appreciation is expressed for the telephone interview

held on 9/29/04, between Examiner Rachuba and counsel. The question as to whether

there is a generic independent claim was reviewed. It was agreed that independent

claim 1 is generic because of the claim text "at least one aperture" and "at least one

membrane" set forth in claim 1.

Claim Amendments: Consistent with that identified text of claim 1, claims 8,

9, 13, and 18-20 have been amended to become generic by the addition of the "at least

one" text to the "member" or "flexible member" or "flexible membrane". Also, claim

3 has been amended to conform the "member" to the antecedent in parent claim 2. In

claim 7, "separate groups" of apertures phrase is now separately defined in the

App. No. 10/607,613

Amend. Dated 10/4/04

Response To Action dated 8/3/04

first clause where it was first introduced, and the "the at least one membrane" clause

is amended to more clearly define species 2. Claims 12 and 13 have also been

amended to refer to proper antecedents (at least one pocket, claims 12; at least one

flexible member, claim 13). Entry of these amendments is respectfully requested.

Responsiveness: It is believed that this paper responds to all of the

requirements of Action paragraphs 1 and 2. Examination on the merits is respectfully

requested.

Should the Examiner have any questions concerning this matter, the

undersigned can be reached at the telephone number set out below.

Respectfully submitted,

MARTINE & PENILLA, LLP

Chester E. Martine,

Reg. No. 19,711

710 Lakeway Drive, Suite 170

Sunnyvale, CA 94085

Telephone (408) 749-6900

Customer No. 25920